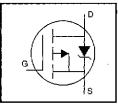
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## HEXFET<sup>®</sup> Power MOSFET

International

- Dynamic dv/dt Rating
- Repetitive Avalanche Rated
- P-Channel
- Fast Switching
- Ease of Paralleling
- Simple Drive Requirements

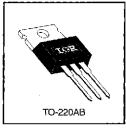


$$V_{DSS} = -200V$$
$$R_{DS(on)} = 0.50\Omega$$
$$I_{D} = -11A$$

## Description

Third Generation HEXFETs from International Rectifier provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 watts. The low thermal resistance and low package cost of the TO-220 contribute to its wide acceptance throughout the industry.



### Absolute Maximum Ratings

	Parameter	Max.	Units	
I <sub>D</sub> @ T <sub>C</sub> = 25°C	Continuous Drain Current, VGS @ -10 V	-11		
Ip @ Tc = 100°C	Continuous Drain Current, VGs @ -10 V	-6.8	A	
IDM	Pulsed Drain Current ①	-44		
P <sub>D</sub> @ T <sub>C</sub> = 25°C	Power Dissipation	125	W	
	Linear Derating Factor	1.0	W/₂C	
V <sub>GS</sub>	Gate-to-Source Voltage	±20	V	
EAS	Single Pulse Avalanche Energy ②	700	l mJ	
ÍAR	Avalanche Current ①	-11	A	
EAR	Repetitive Avalanche Energy ①	13	mJ	
dv/dt	Peak Diode Recovery dv/dt ③	-5.0	V/ns	
ΤJ	Operating Junction and	-55 to +150		
Т <sub>STG</sub>	Storage Temperature Range		°C	
	Soldering Temperature, for 10 seconds	300 (1.6mm from case)		
	Mounting Torque, 6-32 or M3 screw	10 lbf•in (1.1 N•m)		

## **Thermal Resistance**

	Parameter	Min.	Тур.	Max.	Units
Read	Junction-to-Case			1.0	
Recs	Case-to-Sink, Flat, Greased Surface		0.50	—	°C/W
R <sub>RJA</sub>	Junction-to-Ambient	_	. —	62	

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	Parameter	Min.	Тур.	Max.	Units	Test Conditions
V(BR)DSS	Drain-to-Source Breakdown Voltage	-200		_	V	V <sub>GS</sub> =0V, I <sub>D</sub> =-250μA
ΔV(8R)DSS/ΔTJ	Breakdown Voltage Temp. Coefficient	_	-0.20	-	V/°C	Reference to 25°C, ID=-1mA
RDS(on)	Static Drain-to-Source On-Resistance	_	— ····	0.50	Ω	V <sub>GS</sub> =-10V, I <sub>D</sub> =-6.6A ④
V <sub>GS(th)</sub>	Gate Threshold Voltage	-2.0	-	-4.0	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250µA
gis	Forward Transconductance	4.1	_	I	S	V <sub>DS</sub> =-50V, I <sub>D</sub> =-6.6A ⊕
· · · ·-	Drois to Course Lookage Current	-	-	-100	μA	V <sub>DS</sub> =-200V, V <sub>GS</sub> =0V
loss	Drain-to-Source Leakage Current	_	—	-500	μα	Vps=-160V, Vgs=0V, TJ=125°C
less	Gate-to-Source Forward Leakage		-	-100	nA	V <sub>QS</sub> =-20V
1655	Gate-to-Source Reverse Leakage	_	—	100	ריי	V <sub>GS</sub> =20V
Qg	Total Gate Charge		- I	44		I <sub>D</sub> =-11A
Q <sub>gs</sub>	Gate-to-Source Charge	-		7.1	nC	V <sub>DS</sub> =-160V
Q <sub>gd</sub>	Gate-to-Drain ("Miller") Charge	—	-	27		V <sub>GS</sub> ≕-10V See Fig. 6 and 13 ④
td(on)	Turn-On Delay Time	. —	14	_		V <sub>DD</sub> =-100V
t <sub>r</sub>	Rise Time	_	43		ns	I <u>D</u> ≂-11A
td(off)	Turn-Off Delay Time	_	39	_		R <sub>G</sub> =9.1Ω
ti	Fall Time	_	38			$R_{D}=8.6\Omega$ See Figure 10 $\circledast$
Lo	Internal Drain inductance	-	4.5	_		Between lead, c 6 mm (0.25in.)
					nH	from package
Ls	Internal Source Inductance	—	7.5	_		and center of
Ciss	Input Capacitance	_	1200	_		V <sub>GS</sub> =0V
Coss	Output Capacitance		370		рF	V <sub>DS</sub> =-25V
Crss	Reverse Transfer Capacitance		81		! 1	f=1.0MHz See Figure 5

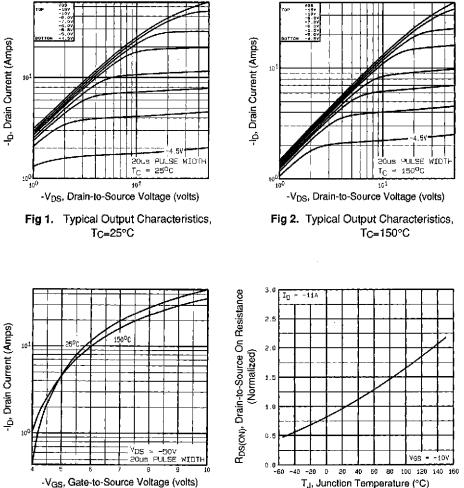
## Electrical Characteristics @ TJ = 25°C (unless otherwise specified)

## Source-Drain Ratings and Characteristics

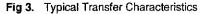
_	Parameter	Min.	Тур.	Max.	Units	Test Conditions	
ls	Continuous Source Current (Body Diode)	_		-11	A	MOSFET symbol showing the	
IsM	Pulsed Source Current (Body Diode) ①		_	-44		integral reverse eventse p-n junction diode.	
VSD	Diode Forward Voltage			-5.0	V	TJ=25°C, IS=-11A, VGS=0V @	
t <sub>rr</sub>	Reverse Recovery Time		250	300	ns	T_=25°C, I_=-11A	
Qrr	Reverse Recovery Charge	_	2.9	3.6	μC	di/dt=100A/μs ⊛	
t <sub>on</sub>	Forward Turn-On Time	Intrinsi	Intrinsic turn-on time is neglegible (turn-on is dominated by LS+LD)				

#### Notes:

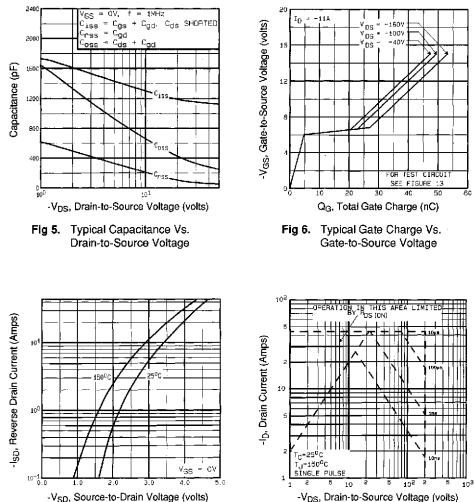
- ① Repetitive rating; pulse width limited by max, junction temperature (See Figure 11)
- V<sub>DD</sub>=-50V, starting T<sub>J</sub>=25°C, L=8.7mH R<sub>G</sub>=25Ω, I<sub>AS</sub>=-11A (See Figure 12)
- B Pulse width  $\leq$  300  $\mu$ s; duty cycle  $\leq$ 2%.



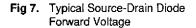
-VGS, Gate-to-Source Voltage (volts)

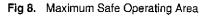


Normalized On-Resistance Fig 4. Vs. Temperature







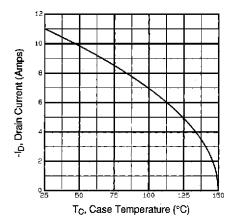


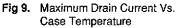
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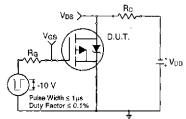


Fig 10a. Switching Time Test Circuit

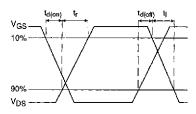
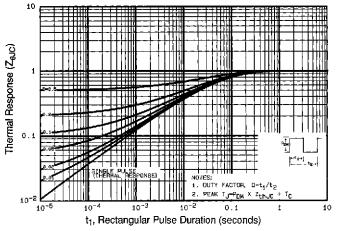


Fig 10b. Switching Time Waveforms





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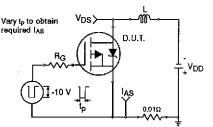


Fig 12a. Unclamped Inductive Test Circuit

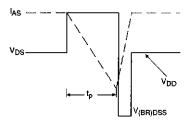


Fig 12b. Unclamped Inductive Waveforms

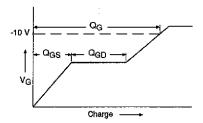


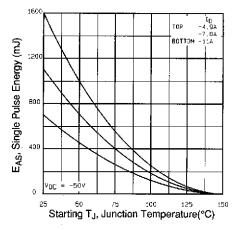
Fig 13a. Basic Gate Charge Waveform

Appendix A: Figure 14, Peak Diode Recovery dv/dt Test Circuit - See page 1506

Appendix B: Package Outline Mechanical Drawing - See page 1509

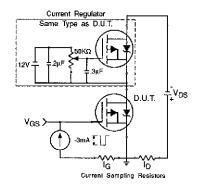
Appendix C: Part Marking Information - See page 1516

Appendix E: Optional Leadforms – See page 1525



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Fig 12c. Maximum Avalanche Energy Vs. Drain Current







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